@ EPODOC / EPO

PN - JP51018245 A 19760213 PNEP - JP54008458B B 19790416 - JP976727C C 19791030 - B23K35/363&A; B23K35/363&C; H05K3/34&503Z

FT - 5E319/AC01; 5E319/CC23; 5E319/CD01; 5E319/CD21; 5E319/CD52; 5E319/GG20

PA - (A)

TAMURA KAKEN COLTD

IN - (A)

NAKAMURA KOZO

AP - JP19740089115 19740805 PR - JP19740089115 19740805

DT - !

@ WPI / Thomson

AN - 1976-23519X [13]

- Delustering if for soldering printed circuits - contains inorg oxide powder and/or org acid metal salt powder

AB - An inorg, oxide fine powder and/or org, acid metal salt fine powder is/are added to a flux base consisting of rosin type resin, activator and org. solvent. The inorg, oxide may be silicic acid anhydride, clay, titanium oxide, silica gel, etc. and the org, acid metal salt may be aluminium stearate, aluminium oleate, aluminium palmitate, etc. The surface of the welded areas is delustered and non-corrosive.

IW - DELUSTERED FLUX SOLDER PRINT CIRCUIT CONTAIN OXIDE POWDER ACID METAL SALT

A 19760213 DW197613 PN - JP51018245 B 19790416 DW197919 JP54008458B

ICAI - B23K35/362; B23K35/363; H05K3/34

icci - B23K35/362; H05K3/34 MC - L03-D03F L03-H04E

DC - L03 M23

- P55

- V04

PA - (TAMU-N) TAMURA KAKEN CO LTD

AP - JP19740089115 19740805